

## 无铅厚膜贴片排阻承认书-FA 系列

### Approval Specification for Lead Free Thick Film Chip Array Resistors - Type FA

#### 1. 范围 (scope) :

适用于本公司所生产的无铅、无卤之无铅厚膜贴片排阻 FA 系列

This specification applies to lead free thick film chip array resistors which meet requirements of Pb free and halogen free.

#### 2. 产品料号 (part number) :

FA034A 1/10W 5% 75Ω

FA034AJA0750G




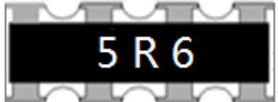
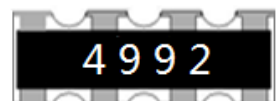
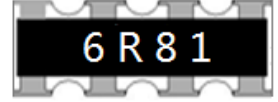

| FA   | 034A   | J  | A   | 0750  | G  |
|--|--|--|---|---|--|
| 类型(Type)<br>FA: 无铅厚膜<br>贴片排阻<br>(lead free<br>thick film chip<br>array<br>resistors) | 尺寸(Size)<br>024A=8P4R(0402)<br>034A=8P4R(0603) | 公差<br>Tolerance<br>F=±1%<br>G=±2%<br>J=±5% | 额定功率<br>Rated Power<br>A= 1/10W<br>F= 1/16W | 阻值<br>±1% :<br>49R9=49.9Ω<br>1002=10KΩ<br>±2%, ±5% :<br>06R8=6.8Ω<br>0750=75Ω | 包装代码<br>Packing Code<br>G= reel (卷装)<br>V= bulk (散料)<br>S= Double Standard<br>Quantity (两倍卷<br>盘标准包装量) |



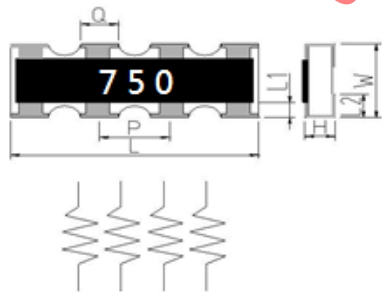
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#### 3. 电阻本体字码标示(Marking on the Resistor's Body):

|  |  |  |
|--|--|--|
| <p>※ 公差±2%、±5%的产品，以三字码标示，前两位表示阻值的有效数字，最后一位表示10的乘幂<br/> <math>\pm 2\%</math>、<math>\pm 5\%</math> tolerance product: the marking is 3 digits, the first 2 digits are significant figures of resistance value and the 3rd one denotes the power number of 10, (<math>10^x</math>)</p> <p>※ ±1%的产品，以四字码标示，前三位表示阻值的有效数字，最后一位表示10的乘幂<br/> <math>\pm 1\%</math> tolerance product: the marking is 4 digits, the first 3 digits are significant figures of resistance value and the 4th one denotes the power number of 10, (<math>10^x</math>)</p> <p>※ 0 欧姆产品，采用 000 三位代码标示。<br/> <math>0\Omega</math> Products, use 000 3digits code to indicate the resistance value.</p> |    | $750 = 75 \times 10^0 = 75\Omega$  |
|  |    | $10\Omega$ 以下标示: $5R6 = 5.6\Omega$<br>Below $10\Omega$ : $5R6 = 5.6\Omega$       |
|  |    | $4992 = 499 \times 10^2 = 49.9K\Omega$   |
|  |    | $100\Omega$ 以下标示: $6R81 = 6.81\Omega$<br>Below $100\Omega$ : $6R81 = 6.81\Omega$ |
|  |  | $000 = 0\Omega$  |

#### 4. 尺寸 (dimension) :

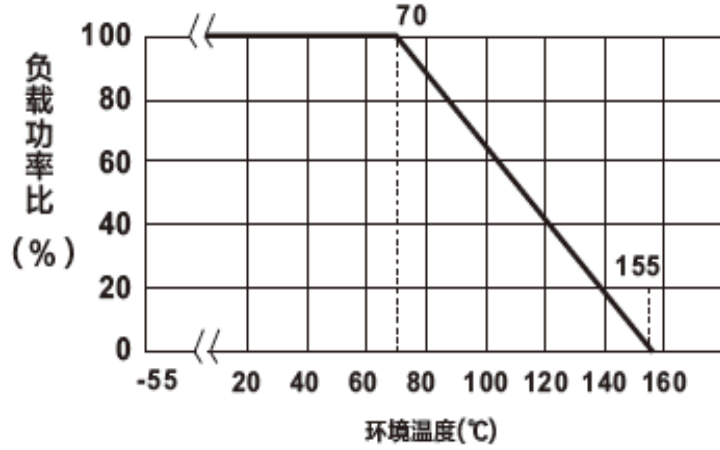
|                 |  |           |           |           |           |           |           |
|-----------------|--|-----------|-----------|-----------|-----------|-----------|-----------|
| 尺寸<br>dimension | FA024A/FA034A<br> |           |           |           |           |           |           |
|                 | 单位 (unit) : mm   |           |           |           |           |           |           |
| 型别 (Type)       | L  | W         | H         | L1        | Q         | P         | L2        |
| FA024A          | 2.00±0.10  | 1.00±0.10 | 0.40±0.05 | 0.18±0.10 | 0.33±0.10 | 0.50±0.10 | 0.26±0.10 |
| FA034A          | 3.20±0.20  | 1.50±0.20 | 0.55±0.05 | 0.30±0.15 | 0.50±0.15 | 0.80±0.15 | 0.30±0.20 |



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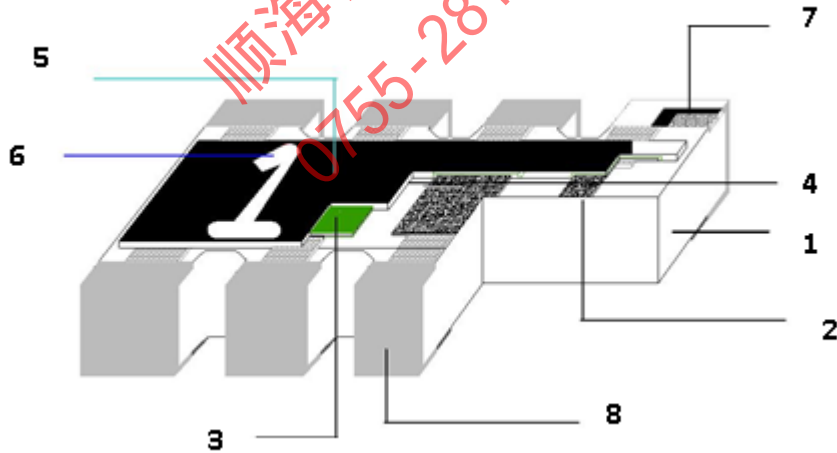
5. 功率衰减曲线 ( Derating Curve ) :



工作温度范围 (Operating Temperature Range) :  $-55^{\circ}\text{C} \sim +155^{\circ}\text{C}$ ;

储存条件 (storage condition) :  $5 \sim 30^{\circ}\text{C}$ ,  $30 \sim 75\% \text{RH}$ .

6.电阻结构 (Construction) :





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| No. | 结构<br>construction             | 主要材料<br>Major material                  |
|-----|--------------------------------|---|
| 1   | 陶瓷基板<br>Ceramic substrate      | 三氧化二铝<br>Al <sub>2</sub> O <sub>3</sub> |
| 2   | 银电极<br>Conductive layer        | 银<br>Ag                                 |
| 3   | 阻体层<br>Resistive layer         | 氧化钌+玻璃<br>RuO <sub>2</sub> + glass      |
| 4   | 内保护层<br>Inner protective layer | 玻璃<br>Glass                             |
| 5   | 外保护层<br>Outer Protective layer | 环氧树脂<br>Epoxy                           |
| 6   | 文字<br>Marking                  | 环氧树脂<br>Epoxy                           |
| 7   | 镍电极<br>Ni plating layer        | 镍<br>Ni                                 |
| 8   | 锡电极<br>Sn plating layer        | 雾锡<br>Matte Tin                         |

#### 7. 电气特性 (electrical characteristics) :

| 型别 Type                                 | FA024A | FA034A |
|---|--------|--------|
| 阻值(±1%,±2%,±5%)<br>Resistance           | 1Ω~1MΩ | 1Ω~1MΩ |
| 额定功率<br>Rated power                     | 1/16W  | 1/10W  |
| 最大工作电压<br>Max Working Voltage           | 50V    | 50V    |
| 最大过负荷电压<br>Max Overload Voltage         | 100V   | 100V   |
| 绝缘耐压<br>Dielectric Withstanding Voltage | 220V   | 430V   |
| 零欧姆电阻阻值<br>Resistance Value of Jumper   | <50mΩ  | <50mΩ  |
| 零欧姆额定电流<br>Rated Current of Jumper      | 1A     | 1A     |



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备注 (remark) :

※ 额定电压计算公式 (The rated voltage is calculated by the following formula) :

$$E = \sqrt{RP}$$

E : 额定电压 (Rated Voltage) (V)

P : 额定功率 (Rated Power) (W)

R : 电阻阻值 (Resistance) (ohm)

※ 如果计算出的电压超过此型别的最大工作电压, 则此型别的最大工作电压为此电阻的额定电压。

In case the value calculated by the formula exceed the maximum working voltage as above table 7, the maximum working voltage shall be regarded as rated voltage.

顺海科技  
0755-28100016



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#### 8. 性能(Performance Specifications)

| 内容<br>Item                                    | 测试方法<br>Test Methods | 测试条件<br>Test Conditions   | 规格<br>Specification  |
|---|----------------------|---|--|
| 温度系数<br>Temperature<br>Coefficient            | JIS C 5201 4.8       | $TCR = (R - R_0) / (t - t_0) R_0 \times 10^6$ (ppm)<br>R <sub>0</sub> 电阻在室温下的阻值(resistance at room temperature)<br>R 电阻在 125°C 或 -55°C 下的阻值(resistance at 125°C or -55°C)<br>t <sub>0</sub> 室温(room temperature)<br>t 测试温度 (test temperature 125°C or -55°C)            | ±200 PPM/°C  |
| 焊锡性<br>Solderability                          | JIS C 5201 4.17      | 沾助焊剂后浸入锡炉，锡炉温度 245±5°C，时间 3±0.5 秒。<br>Dip the terminal in a flux and then dip into a soldering bath at 245±5°C for 3±0.5sec.  | 最少 95% 面积上锡<br>(Min 95% coverage)  |
| 绝缘电阻<br>Insulation<br>resistance              | JIS C 5201 4.6       | 电阻本体上加载绝缘耐压 60±5 秒后，测量绝缘阻抗。<br>Applied the dielectric withstanding voltage on the center of body for 60±5seconds. Then measure insulation resistance.   | >10GΩ  |
| 绝缘耐压<br>Dielectric<br>withstanding<br>voltage | JIS C 5201 4.7       | 电阻本体上加载绝缘耐压 60±5 秒。<br>Applied the dielectric withstanding voltage on the center of body for 60±5seconds.   | 无击穿、飞弧及可见机械性损伤<br>No evidence of flashover, mechanical damage arcing or insulation breakdown |
| 短时间过负荷<br>Short-time<br>overload              | JIS C 5201 4.13      | 加载 2.5 倍的额定电压，时间 5 秒后测量试验前后的阻值变化率。<br>Applied 2.5 times of rated voltage for 5 second. Measure the variation of resistance.<br><br>$\Delta R\% = \frac{R_2 - R_1}{R_1} * 100 \text{-----} (\%)$ R1 = 试验前阻值(resistance before test)<br>R2 = 试验后阻值(resistance after test) | ±(1.0% +0.05Ω) Max   |



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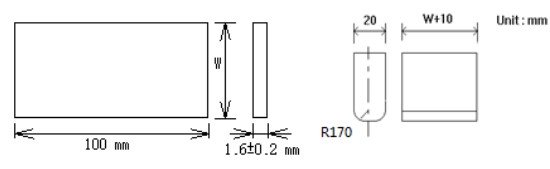

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| 内容<br>Item                     | 测试方法<br>Test Methods | 测试条件<br>Test Conditions  | 规格<br>Specification |
|--------------------------------|----------------------|--|---------------------|
| 温度循环<br>Temperature<br>Cycling | JIS C 5201 4.19      | 电阻放入温度循环机中，温度 155±2℃ 至 -55±3℃，共 5 个循环。<br>量测试验前后阻值变化率。<br>Put specimen in a chamber which temperature can be changed to 155±2℃ or -55±3℃, repeated 5 times.<br>Measure the variation of resistance.<br>$\Delta R\% = \frac{R_2 - R_1}{R_1} * 100 \text{-----} (\%)$ R1 = 试验前阻值(resistance before test)<br>R2 = 试验后阻值(resistance after test)  | ±(2.0%+0.05Ω) Max   |
| 耐湿特性<br>Humidity               | JIS C 5201 4.24      | 电阻放入恒温恒湿箱，温度 40±2℃，湿度 90~95 %RH;通电额定电压 1.5 小时，断电 0.5 小时 ;重复通断电至试验时间 1000 <sup>+48</sup> /0 小时. 量测试验前后阻值变化率。<br>Put the specimen in a chamber at 40±2℃ temperature and 90~95% relative humidity, then applied rated voltage for 1.5H and rested for 0.5H repeatedly till total test time is 1000 <sup>+48</sup> /0.. Measure the variation of resistance.<br>$\Delta R\% = \frac{R_2 - R_1}{R_1} * 100 \text{-----} (\%)$ R1 = 试验前阻值(resistance before test)<br>R2 = 试验后阻值(resistance after test) | ±(2.0%+0.05Ω) Max   |
| 负荷寿命<br>Load life              | JIS C 5201<br>4.25.1 | 电阻放入恒温箱中，温度 70±2℃，ON TIME:1.5H，OFF TIME:0.5H，通电额定电压 1000 <sup>+24</sup> /0 小时，量测试验前后阻值变化率。<br>Put the specimen in a chamber at 70±2℃ temperature, ON TIME:1.5H OFF TIME:0.5H，and applied rated voltage for 1000 <sup>+24</sup> /0H. Measure the variation of resistance.<br>$\Delta R\% = \frac{R_2 - R_1}{R_1} * 100 \text{-----} (\%)$ R1 = 试验前阻值(resistance before test)<br>R2 = 试验后阻值(resistance after test)   | ±(2.0%+0.05Ω) Max   |



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| 内容<br>Item                  | 测试方法<br>Test Methods   | 测试条件<br>Test Conditions  | 规格<br>Specification |
|-----------------------------|------------------------|--|---------------------|
| 端子弯曲<br>Terminal bending    | JIS C 5201 4.33        | <p>电阻焊接在测试板上进行弯折,弯折保持时间 20±1 秒,弯曲 1<sup>+0.2</sup>%mm; 量测试前后阻值变化率</p> <p>Specimen shall be mounted on test board, then bend the board and maintained for 20±1s. the distance of bending is 1<sup>+0.2</sup>%mm. Measure the variation of resistance.</p> <p style="text-align: center;">测试板 (test board) 压头 (jig)</p> <div style="text-align: center;">  </div> <div style="text-align: center;">  </div> <p style="text-align: center;"> <math display="block">\Delta R\% = \frac{R_2 - R_1}{R_1} * 100 \text{-----} (\%)</math> </p> <p>R1 = 试验前阻值(resistance before test)<br/> R2 = 试验后阻值(resistance after test)</p> | ±(1.0%+0.05Ω) Max   |
| 温湿循环<br>Moisture resistance | MIL-STD-202 METHOD 106 | <p>25 °C~65 °C,90~100%RH, 2.5 小时; 65 °C 90~100%RH, 3小时; 65°C~25°C,80~100%RH,2.5小时,10个循环,试验结束24±4小时后进行测试.</p> <p>25°C~65°C,90~100%RH, 2.5H;<br/> 65°C 90~100%RH, 3H; 65°C~25°C 80~100%RH, 2.5H, 10 cycles, Measurement at 24±4 hours after test conclusion.</p> <p style="text-align: center;"> <math display="block">\Delta R\% = \frac{R_2 - R_1}{R_1} * 100 \text{-----} (\%)</math> </p> <p>R1 = 试验前阻值(resistance before test)<br/> R2 = 试验后阻值(resistance after test)</p>   | ±(2.0% +0.05Ω) Max  |





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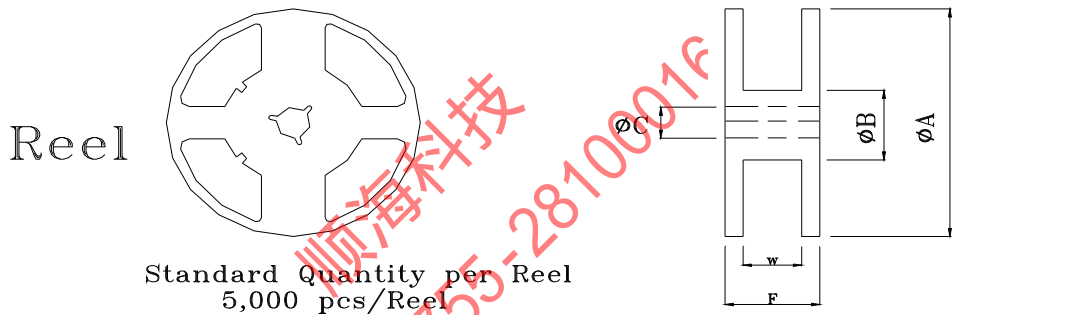
#### 9. 包装规格 (Tapping Specification)

##### 9.1 卷盘尺寸 (reel dimension)

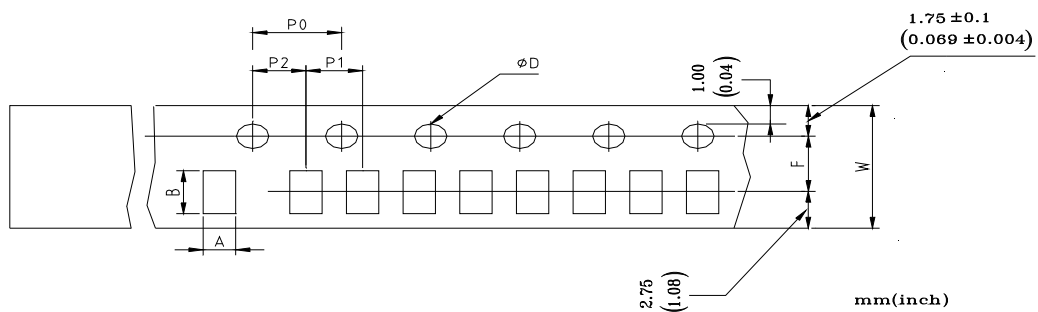
| 尺寸<br>Dimensions |      | A           | B           | C           | F           | W           |
|------------------|------|-------------|-------------|-------------|-------------|-------------|
| FA024A<br>FA034A | mm   | 178±2.0     | 60.0±1.0    | 13.5±0.5    | 11.4±0.1    | 9.00±0.3    |
|                  | Inch | 7.008±0.079 | 2.362±0.039 | 0.531±0.020 | 0.449±0.039 | 0.354±0.012 |

※ 备注 (Remark) :

- (1) FA024A 每卷 10,000 pcs  
FA024A Quantity per Reel 10,000 pcs/Reel
- (2) FA034A 每卷 5,000 pcs  
FA034A Quantity per Reel 5,000 pcs/Reel



##### 9.2 包装尺寸 (packing dimension)



Unit: mm

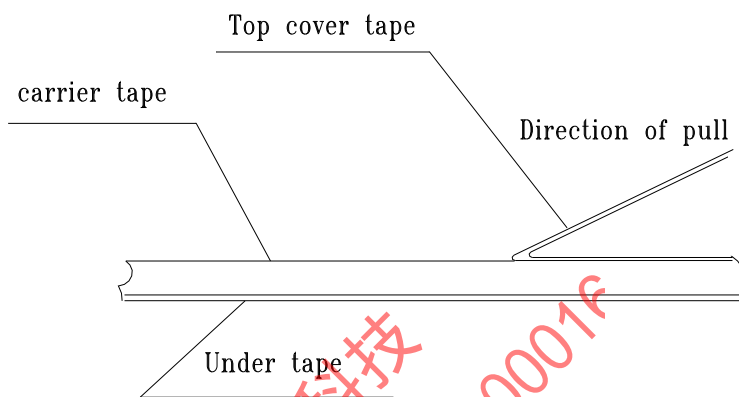
| 尺寸<br>Dimensions | A         | B         | D                                   | F         | P0        | P1        | P2        | W         |
|------------------|-----------|-----------|-------------------------------------|-----------|-----------|-----------|-----------|-----------|
| FA024A           | 1.20±0.10 | 2.20±0.10 | 1.50± <sub>0.0</sub> <sup>0.1</sup> | 3.50±0.05 | 4.00±0.10 | 4.00±0.10 | 2.00±0.05 | 8.00±0.20 |
| FA034A           | 1.90±0.15 | 3.40±0.20 | 1.50± <sub>0.0</sub> <sup>0.1</sup> | 3.50±0.05 | 4.00±0.10 | 4.00±0.10 | 2.00±0.05 | 8.00±0.20 |



## 10. 上胶带剥离力测试 (Peel force of top cover tape)

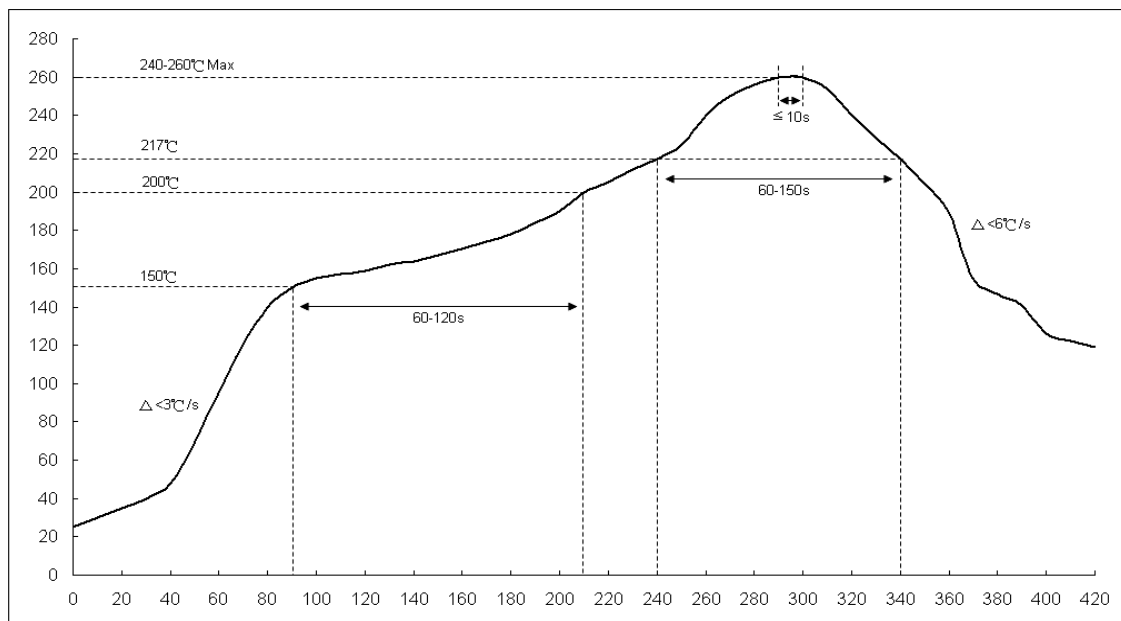
上胶带以 200mm/分钟的速度，沿 165~180 度角的方向进行剥离，如下图所示。纸带的剥离力范围为 10g~70g；载带的剥离力范围为 15~80g。

The top cover tape is pulled at a speed of 200 mm/min with the angle between the tape during peel and the direction of unreeling maintained at 165 to 180 degree as following picture. The peel force of paper carrier tape shall be 0.1N to 0.7N(10 to 70 g), the peel force of plastic carrier tape shall be 0.15N to 0.80N (15 to 80 g)



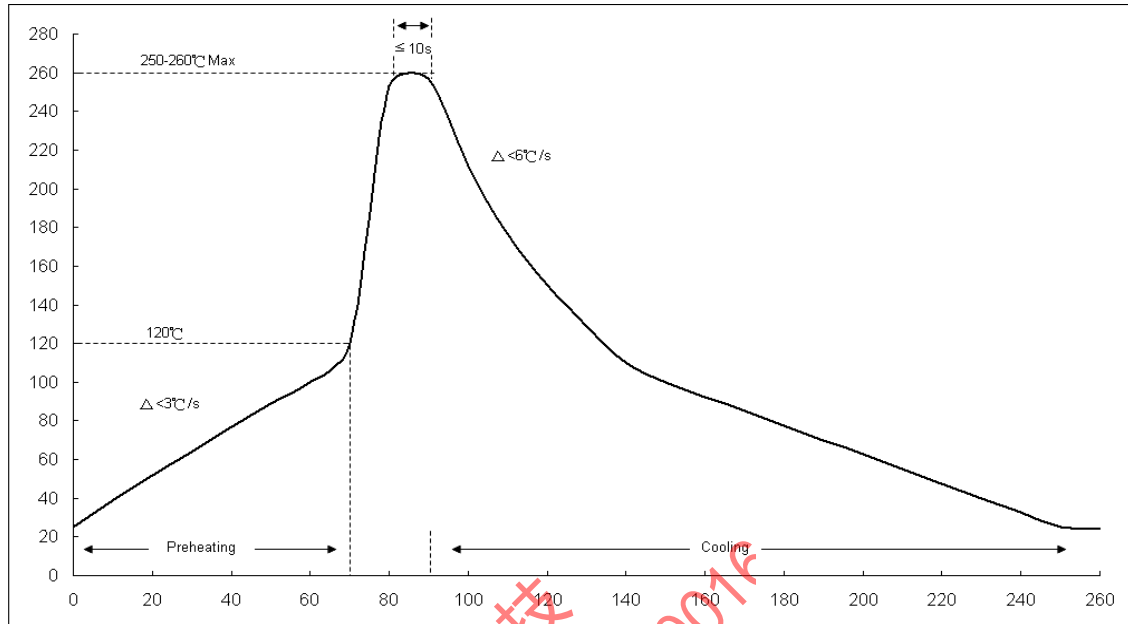
## 11. 焊接 (soldering)

### 11.1 建议回流焊曲线 (Recommend reflow soldering profile)





### 11.2 建议波峰焊曲线 (Recommend wave soldering profile)



### 11.3 手工焊温度 (hand soldering temperature)

烙鐵溫度  $350 \pm 10^{\circ}\text{C}$  3 秒之內，避免烙鐵接觸電阻本體

The iron temperature is  $350 \pm 10^{\circ}\text{C}$ , hand soldering time less than 3S. Avoid solder iron tip direct touch the components body

产品规格及资料如有更改，恕不另行通知。

All product specification and data are subject to change without notice